



Examiner : A. Chambliss
Art Unit : 2827
Docket No.: 52433/544

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.
Serial No. : 09/254,118
Filed : May 19, 1999
For : METHOD OF PARTIALLY PLATING SUBSTRATE FOR
ELECTRONIC DEVICES

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL LETTER

SIR:

Transmitted herewith is an Amendment/Response in the
above-identified patent application.

[X] No additional fee is required.

The fee has been calculated as shown below.

					SMALL ENTITY		OTHER THAN A SMALL ENTITY	
CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDIT. OR FEE	RATE	ADDIT. FEE		
TOTAL 10 MINUS 20 = 0			x6=	\$	x18 =	\$	0.00	
INDEP. 1 MINUS 3 = 0			x18=	\$	x86 =	\$	0.00	
[] FIRST PRESENTATION OF MULTIPLE DEP. CLAIM			x60=	\$	x290=	\$	0.00	
TOTAL								
ADDIT. FEE					\$ OR		\$ 0.00	

[X] The Commissioner is hereby authorized to charge fees under 37 CFR 1.16 and 1.17 which
may be required to Deposit Account 11-0600. A duplicate of this paper is enclosed.

[X] A petition for a one (1) month extension of time and Deposit Account authorization to
cover the extension fee are enclosed.

[] Terminal Disclaimer and Deposit Account Authorization.

I hereby certify that this correspondence is being deposited with
the United States Postal Service as First Class Mail in an
envelope addressed to: Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on April 2, 2004

John J. Kelly, Jr.

Reg. No. 29,182

Respectfully submitted,

KENYON & KENYON

By:

John J. Kelly, Jr.

Reg. No. 29,182